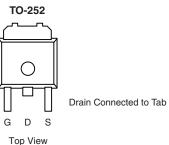


Vishay Siliconix

## N-Channel 60 V (D-S), MOSFET

PRODUCT SUMMARY						
V <sub>DS</sub> (V)	<b>R<sub>DS(on)</sub> (</b> Ω <b>)</b>	I <sub>D</sub> (A) <sup>a</sup>	Q <sub>g</sub> (Typ.)			
60	0.031 at V <sub>GS</sub> = 10 V	9.1	6.5 nC			
00	0.045 at V <sub>GS</sub> = 4.5 V	7.6	0.5 110			



#### **FEATURES**

- Halogen-free According to IEC 61249-2-21 Definition
- TrenchFET<sup>®</sup> Power MOSFET
- 100 % R<sub>g</sub> and UIS Tested •
- Compliant to RoHS Directive 2002/95/EC

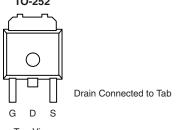
GC

#### **APPLICATIONS**

DC/DC Converters



#### RoHS COMPLIANT HALOGEN FREE



Ordering Information: SUD23N06-31-GE3 (Lead (Pb)-free and Halogen-free)

N-Channel MOSFET

D

<b>ABSOLUTE MAXIMUM RATINGS</b>	<b>S</b> (T <sub>A</sub> = 25 °C, unles	ss otherwise n	oted)	
Parameter	Symbol	Limit	Unit	
Drain-Source Voltage	V <sub>DS</sub>	60	- V	
Gate-Source Voltage		V <sub>GS</sub>		
	T <sub>C</sub> = 25 °C		21.4	
Continuous Drain Current (T. $-150$ °C)	T <sub>C</sub> = 70 °C	1	17.1	
Continuous Drain Current (T <sub>J</sub> = 150 °C)	T <sub>A</sub> = 25 °C	Ι <sub>D</sub>	9.1 <sup>a</sup>	
	T <sub>A</sub> = 70 °C		7.6 <sup>a</sup>	А
Pulsed Drain Current		I <sub>DM</sub>	50	
	T <sub>C</sub> = 25 °C	I	20.8	
Continuous Source-Drain Diode Current	T <sub>A</sub> = 25 °C	۱ <sub>S</sub>	3.8 <sup>a</sup>	
Single Pulse Avalanche Current	L = 0.1 mH	I <sub>AS</sub>	20	
Avalanche Energy		E <sub>AS</sub>	20	mJ
	T <sub>C</sub> = 25 °C		31.25	
Maximum Power Dissipation	T <sub>C</sub> = 70 °C		20	w
Maximum Fower Dissipation	T <sub>A</sub> = 25 °C	PD	5.7 <sup>a</sup>	vv
	T <sub>A</sub> = 70 °C		3.6 <sup>a</sup>	
Operating Junction and Storage Temperature Range		T <sub>J</sub> , T <sub>stg</sub>	- 55 to 150	°C

THERMAL RESISTANCE RATINGS						
Parameter		Symbol	Typical	Maximum	Unit	
Maximum Junction-to-Ambient <sup>a</sup>	$t \le 10 s$	R <sub>thJA</sub>	18	22	°C/W	
Maximum Junction-to-Case	Steady State	R <sub>thJC</sub>	3.2	4.0	0/10	

Notes:

a. Surface mounted on 1" x 1" FR4 board, t  $\leq$  10 s.

## SUD23N06-31

Vishay Siliconix



Parameter	Symbol	Test Conditions	Min.	Тур.	Max.	Unit	
Static							
Drain-Source Breakdown Voltage	V <sub>DS</sub>	$V_{GS} = 0 \text{ V}, I_{D} = 250 \mu\text{A}$	60			V	
V <sub>DS</sub> Temperature Coefficient	$\Delta V_{DS}/T_{J}$	1 050 14		65		mV/°C	
V <sub>GS(th)</sub> Temperature Coefficient	$\Delta V_{GS(th)}/T_J$	I <sub>D</sub> = 250 μA		- 6.3			
Gate-Source Threshold Voltage	V <sub>GS(th)</sub>	$V_{DS} = V_{GS}, I_{D} = 250 \ \mu A$	1.0		3.0	V	
Gate-Source Leakage	I <sub>GSS</sub>	$V_{DS} = 0 V, V_{GS} = \pm 20 V$			± 100	nA	
Zara Cata Valtaga Drain Current		$V_{DS} = 60 \text{ V}, \text{ V}_{GS} = 0 \text{ V}$			1		
Zero Gate Voltage Drain Current	I <sub>DSS</sub>	$V_{DS} = 60 \text{ V}, \text{ V}_{GS} = 0 \text{ V}, \text{ T}_{J} = 70 ^{\circ}\text{C}$	2		20	- μΑ	
On-State Drain Current <sup>a</sup>	I <sub>D(on)</sub>	$V_{DS} \ge 5 \text{ V}, \text{ V}_{GS} = 10 \text{ V}$	50			A	
Drain Course On State Desistance		V <sub>GS</sub> = 10 V, I <sub>D</sub> = 15 A		0.025	0.031	Ω	
Drain-Source On-State Resistance <sup>a</sup>	R <sub>DS(on)</sub>	V <sub>GS</sub> = 4.5 V, I <sub>D</sub> = 10 A		0.037	0.045		
Forward Transconductance <sup>a</sup>	9 <sub>fs</sub>	V <sub>DS</sub> = 15 V, I <sub>D</sub> = 15 A		20		S	
Dynamic <sup>b</sup>		·					
Input Capacitance	C <sub>iss</sub>			670		pF	
Output Capacitance	C <sub>oss</sub>	V <sub>DS</sub> = 25 V, V <sub>GS</sub> = 0 V, f = 1 MHz		140			
Reverse Transfer Capacitance	C <sub>rss</sub>			60			
Total Cata Charge	0	$V_{DS} = 30$ V, $V_{GS} = 10$ V, $I_{D} = 23$ A		11	17	nC	
Total Gate Charge	Qg			6.5	13		
Gate-Source Charge	Q <sub>gs</sub>	$V_{DS} = 30$ V, $V_{GS} = 4.5$ V, $I_{D} = 23$ A		3.0		nC	
Gate-Drain Charge	Q <sub>gd</sub>			3.0			
Gate Resistance	Rg	f = 1 MHz		1.6	3.2	Ω	
Turn-On Delay Time	t <sub>d(on)</sub>			18	30		
Rise Time	t <sub>r</sub>	$V_{DD}$ = 30 V, $R_L$ = 1.3 $\Omega$		250	400		
Turn-Off Delay Time	t <sub>d(off)</sub>	$I_D \cong 23$ A, $V_{GEN}$ = 4.5 V, $R_g$ = 1 $\Omega$		35	55		
Fall Time	t <sub>f</sub>			68	110		
Turn-On Delay Time	t <sub>d(on)</sub>			8	15	ns	
Rise Time	t <sub>r</sub>	$V_{DD}$ = 30 V, $R_L$ = 1.3 $\Omega$		15	25		
Turn-Off Delay Time	t <sub>d(off)</sub>	$\text{I}_\text{D}\cong$ 23 A, $\text{V}_\text{GEN}$ = 10 V, $\text{R}_\text{g}$ = 1 $\Omega$		30	45		
Fall Time	t <sub>f</sub>			25	40		
Drain-Source Body Diode Characteris	tics						
Continuous Source-Drain Diode Current	۱ <sub>S</sub>	T <sub>C</sub> = 25 °C			20.8	^	
Pulse Diode Forward Current <sup>a</sup>	I <sub>SM</sub>				50	A	
Body Diode Voltage	V <sub>SD</sub>	I <sub>S</sub> = 15 A		1.0	1.5	V	
Body Diode Reverse Recovery Time	t <sub>rr</sub>			30	60	ns	
Body Diode Reverse Recovery Charge	Q <sub>rr</sub>			35	70	nC	
Reverse Recovery Fall Time	ta	l <sub>F</sub> = 15 A, dl/dt = 100 A/μs, T <sub>J</sub> = 25 °C		20			
Reverse Recovery Rise Time	t <sub>b</sub>			10		ns	

Notes:

a. Pulse test; pulse width  $\leq$  300  $\mu s,$  duty cycle  $\leq$  2 %.

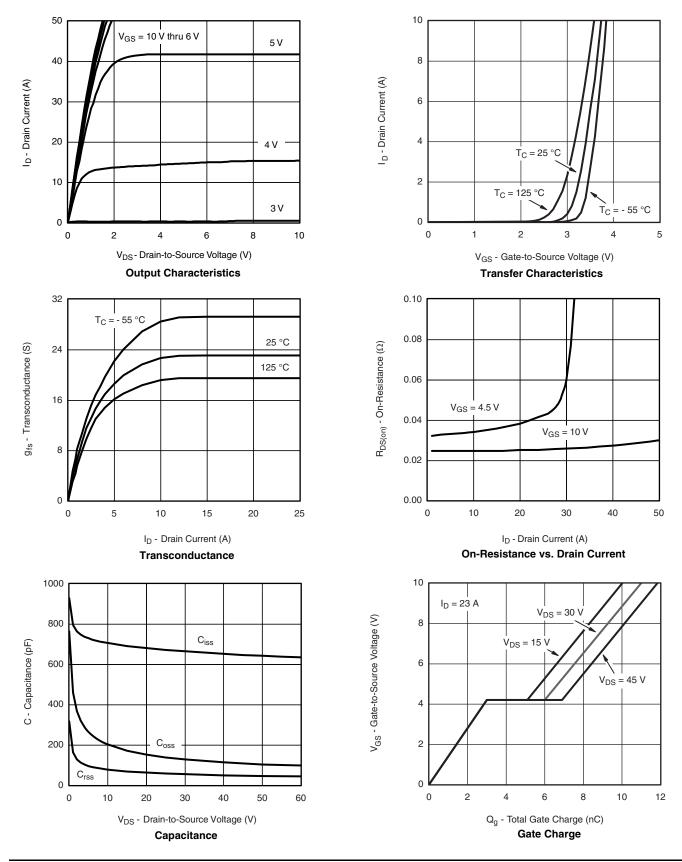
b. Guaranteed by design, not subject to production testing.

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.



## SUD23N06-31 Vishay Siliconix

#### TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)



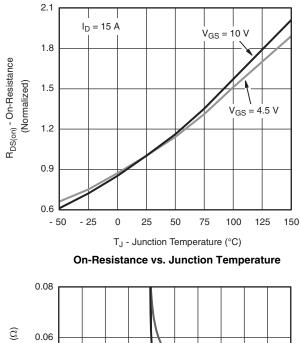
Document Number: 68857 S11-0181-Rev. B, 07-Feb-11

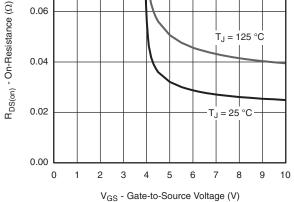
## SUD23N06-31



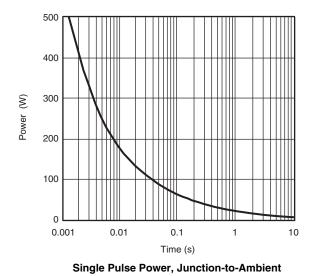
### Vishay Siliconix

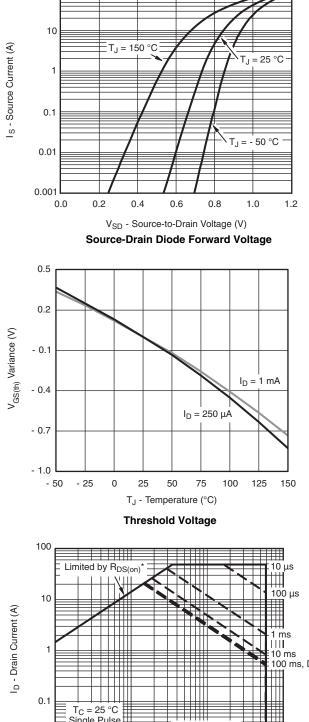
#### TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)



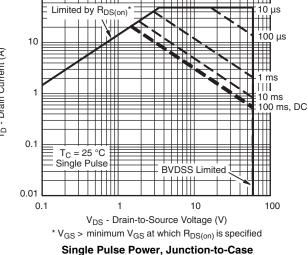








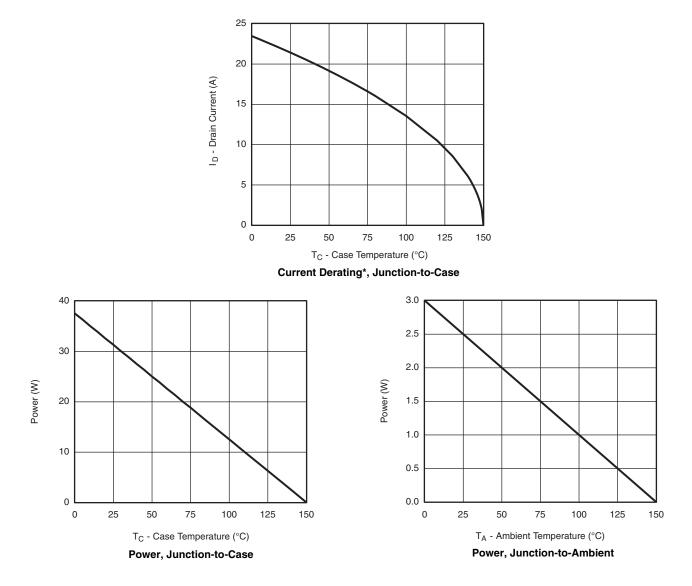
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## SUD23N06-31 Vishay Siliconix

#### TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)

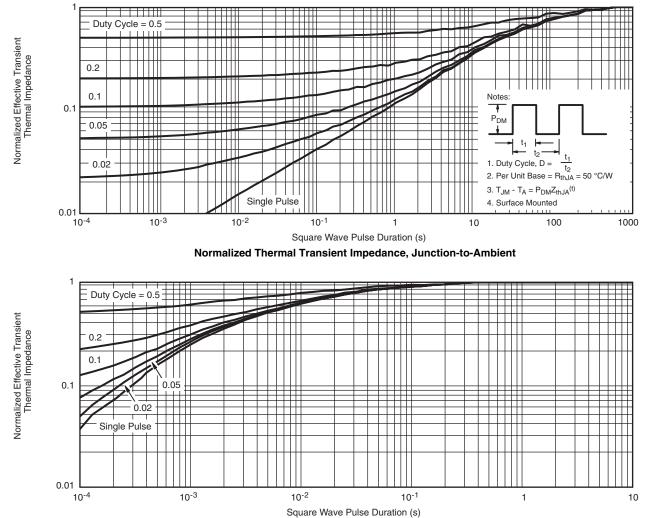


\* The power dissipation  $P_D$  is based on  $T_{J(max)} = 150$  °C, using junction-to-case thermal resistance, and is more useful in settling the upper dissipation limit for cases where additional heatsinking is used. It is used to determine the current rating, when this rating falls below the package limit.

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#### TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)



Normalized Thermal Transient Impedance, Junction-to-Case

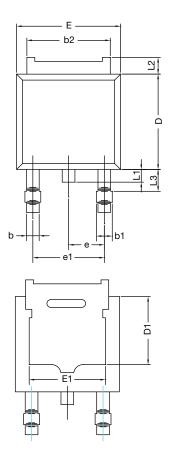
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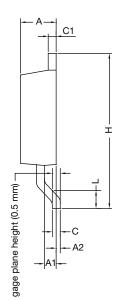


## Package Information

Vishay Siliconix

#### **TO-252AA CASE OUTLINE**





	MILLIN	IETERS	INCHES		
DIM.	MIN.	MAX.	MIN.	MAX.	
А	2.21	2.38	0.087	0.094	
A1	0.89	1.14	0.035	0.045	
A2	0.030	0.127	0.001	0.005	
b	0.71	0.88	0.028	0.035	
b1	0.76	1.14	0.030	0.045	
b2	5.23	5.44	0.206	0.214	
С	0.46	0.58	0.018	0.023	
C1	0.46	0.58	0.018	0.023	
D	5.97	6.22	0.235	0.245	
D1	4.10	4.45	0.161	0.175	
E	6.48	6.73	0.255	0.265	
E1	4.49	5.50	0.177	0.217	
е	2.28	.28 BSC 0.090 BS		BSC	
e1	4.57 BSC		0.180 BSC		
Н	9.65	10.41	0.380	0.410	
L	1.40	1.78	0.055	0.070	
L1	0.64	1.02	0.025	0.040	
L2	0.89	1.27	0.035	0.050	
L3	1.15	1.52	0.040	0.060	
ECN: T11- DWG: 534	0110-Rev. L, <sup>-</sup> 7	18-Apr-11			

Note

• Dimension L3 is for reference only.

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#### **RECOMMENDED MINIMUM PADS FOR DPAK (TO-252)**



Recommended Minimum Pads Dimensions in Inches/(mm)

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